

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT6252722

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	WEN-SUNG HSU	10/18/2018
	TAO CHENG	10/18/2018
	NAN-CHENG CHEN	10/18/2018
	CHE-YA CHOU	10/18/2018
	WEN-CHOU WU	10/18/2018
	YEN-JU LU	10/18/2018
	CHIH-MING HUNG	10/18/2018
	WEI-HSIU HSU	10/18/2018
RECEIVING PARTY DATA		
Name:	MEDIATEK INC.	
Street Address:	NO.1, DUSING 1ST RD., HSINCHU SCIENCE PARK	
City:	HSINCHU	
State/Country:	TAIWAN	
Postal Code:	30078	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	16994764
CORRESPONDENCE DATA		
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NAME OF SUBMITTER:	DANIEL R. MCCLURE	
SIGNATURE:	/Daniel R. McClure/	

PATENT

DATE SIGNED:	08/17/2020
	This document serves as an Oath/Declaration (37 CFR 1.63).
Total Attachments: 2 source=00817036#page1.tif source=00817036#page2.tif	

ASSIGNMENT OF AND DECLARATION FOR APPLICATION FOR UNITED STATES LETTERS PATENT

WHEREAS Wen-Sung HSU, Tao CHENG, Nan-Cheng CHEN, Che-Ya CHOU, Wen-Chou WU, Yen-Ju LU, Chih-Ming HUNG and Wei-Hsiu HSU

, hereinafter referred to collectively as the assignor and inventor, has invented a certain improvement relating to

SEMICONDUCTOR PACKAGE

☒ said application being attached hereto.

☐ said application having been filed in the United States Patent and Trademark Office on _____, as Application Serial No. _____, and was amended on _____ (if applicable);

☐ the specification of which was filed under the Patent Cooperation Treaty on _____,

Serial No. _____, the United States of America being designated.

AND WHEREAS MEDIATEK Inc., hereinafter referred to as the assignee or applicant, is desirous of acquiring the entire right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof;

NOW THIS WITNESSETH, that for good and valuable consideration paid by said assignee to said assignor, the receipt of which is hereby acknowledged, said assignor hereby assigns, sells and transfers to said assignee, and said assignee's successors and assigns, the full and exclusive right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof; said assignee, and said assignee's successors and assigns, to have, hold, exercise and enjoy the said application, including any and all divisions and continuations thereof, and the said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges and advantages in anywise arising from or appertaining thereto, for and during the term or terms of any and all such patents when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said assignee, and said assignee's successors and assigns, in as ample and beneficial a manner as the said assignor might or could have held and enjoyed the same, if this assignment had not been made.

AND said assignor hereby agrees to perform, upon the request of said assignee, or said assignee's successors or assigns, any and all acts relating to the obtaining or to the asserting of said patents, including any and all renewals, reissues and prolongations thereof.

AND said assignor authorizes and requests the Commissioner of Patents and Trademarks to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said assignee, and said assignee's successors and assigns, in accordance herewith.

As an above-named inventor, I hereby declare that the above-identified application was made or authorized to be made by me, and that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

ASSIGNOR (SOLE OR FIRST INVENTOR):

Signature: Wen-Sung HSU

Legal Name: Wen-Sung HSU

Date: October 18, 2018

ASSIGNOR (SECOND INVENTOR):

Signature: Tao CHENG

Legal Name: Tao CHENG

Date: October 18, 2018

ASSIGNOR (THIRD INVENTOR):

Date: October 18, 2018

Legal Name: Nan-Cheng CHEN

Signature: Nan-Cheng CHEN

ASSIGNOR (FOURTH INVENTOR):

Signature: Che-Ya CHOU

Legal Name: Che-Ya CHOU

Date: October 18, 2018

ASSIGNOR (FIFTH INVENTOR):

Signature: Wen-Chou WU

Legal Name: Wen-Chou WU

Date: October 18, 2018

ASSIGNOR (SIXTH INVENTOR):

Signature: Yen-Ju LU

Legal Name: Yen-Ju LU

Date: October 18, 2018

ASSIGNOR (SEVENTH INVENTOR):

Signature: Chih-Ming HUANG

Legal Name: Chih-Ming HUANG

Date: October 18, 2018

ASSIGNOR (EIGHTH INVENTOR):

Signature: Wei-Hsiu HSU

Legal Name: Wei-Hsiu HSU

Date: October 18, 2018

McClure, Qualey & Rodack, LLP.
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